Lighting ColorPure Green

# LNJ310C6PRA

### Surface Mounting Chip LED

SV (Side View) -Case Type

#### $\blacksquare$ Absolute Maximum Ratings $T_a = 25^{\circ}C$

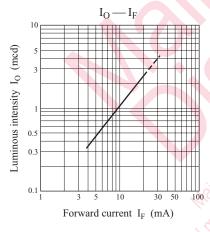
Parameter	Symbol	Rating	Unit	
Power dissipation	$P_{\mathrm{D}}$	60	mW	
Forward current	$I_{\mathrm{F}}$	20	mA	
Pulse forward current *	$I_{FP}$	60	mA	
Reverse voltage	V <sub>R</sub>	4	V	
Operating ambient temperature	T <sub>opr</sub>	-25 to +85	°C	
Storage temperature	T <sub>stg</sub>	-30 to +100	°C	

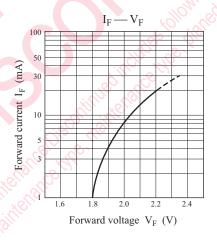
Note) \*: The condition of I<sub>FP</sub> is duty 10%, Pulse width 1 msec.

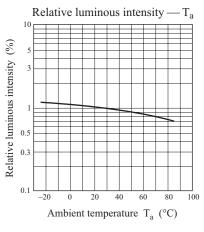
#### ■ Electro-Optical Characteristics $T_a = 25$ °C±3°C

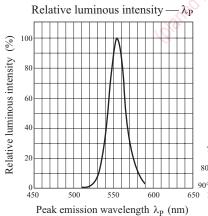
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Parameter	Symbol	Conditions	Min	Тур Ма	x Unit
Luminous intensity *	I <sub>O</sub>	$I_F = 10 \text{ mA}$	0.6	TI CO	mcd
Reverse current	$I_R$	$V_R = 4 V$	111	10	μΑ
Forward voltage	$V_{\rm F}$	$I_F = 10 \text{ mA}$	9170	2.03 2.6	0 V
Peak emission wavelength	$\lambda_{ m P}$	$I_F = 10 \text{ mA}$	lo vier	555	nm
Spectral half band width	Δλ	$I_F = 10 \text{ mA}$	OLILI	20	nm

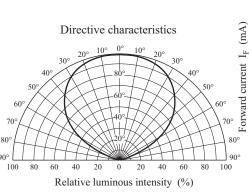
Note) \*: Measurement tolerance: ±20%

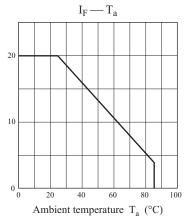








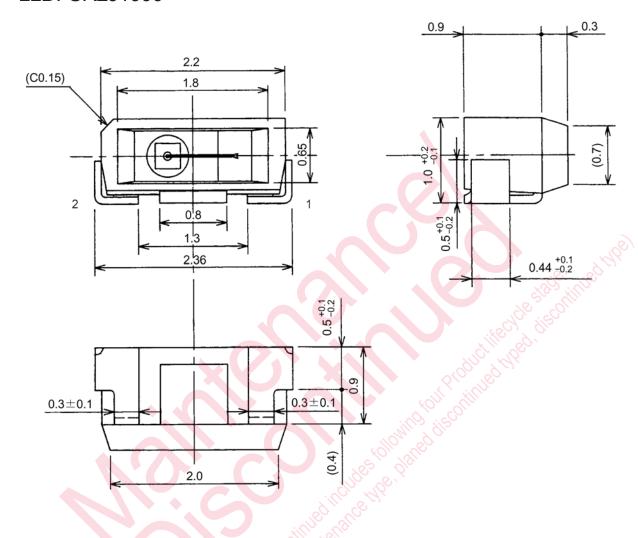




LNJ310C6PRA Panasonic

■ Package (Unit: mm)

### LLDFSR2J1000



- Pin name
  - 1: Anode
  - 2: Cathode

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